

SQAD-TIN - REQUIREMENTS FOR PLATING / SOLDERING ELECTRONIC SUB-COMPONENTS

Vendor shall take specific actions to mitigate the effects of "Tin Whiskers" caused by the use of tin solder. Such actions shall include: (1) the use of tin/lead solders only (in lieu of 100% tin solder) to tin and install electronic components into all circuit boards. This includes soldering performed using automated soldering equipment.